

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE3406AN uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

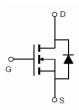
• $V_{DS} = 30V, I_D = 6A$

 $R_{DS(ON)} < 55 \text{m}\Omega$ @ V_{GS} =2.5V

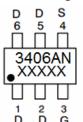
 $R_{DS(ON)}$ < 39m Ω @ V_{GS} =4.5V

 $R_{DS(ON)}$ < 33m Ω @ V_{GS} =10V

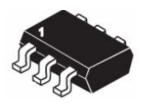
- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- PWM applications
- Load switch
- Power management



Schematic diagram



Marking and pin assignment



SOT23-6L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
3406AN	NCE3406AN	SOT23-6L	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _G S	±12	V
Drain Current-Continuous	I _D	6	Α
Drain Current-Pulsed (Note 1)	I _{DM}	27	А
Maximum Power Dissipation	P _D	2.0	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	62.5	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0V I_D =250 μ A	30	33	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =30V, V_{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±12 V , V_{DS} =0 V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	0.7	0.9	1.4	V	



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NCE3406AN

	R _{DS(ON)}	V _{GS} =2.5V, I _D =4A	-	33	55	mΩ		
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =5A	-	26	39	mΩ		
		V _{GS} =10V, I _D =6A	-	24	33	mΩ		
Forward Transconductance	g FS	V _{DS} =5V,I _D =6A	10	-	-	S		
Dynamic Characteristics (Note4)								
Input Capacitance	C _{lss}	\/ -15\/\/ -0\/	-	595	-	PF		
Output Capacitance	C _{oss}	V_{DS} =15V, V_{GS} =0V, F=1.0MHz	-	39	-	PF		
Reverse Transfer Capacitance	C _{rss}	1 – 1.01/11/12	-	36	-	PF		
Switching Characteristics (Note 4)	Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	3.0	-	nS		
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =2.5 Ω	-	4.5	-	nS		
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =3 Ω	-	25	-	nS		
Turn-Off Fall Time	t _f		-	3.8	-	nS		
Total Gate Charge	Qg	\/ -15\/ -6A	-	9.3	-	nC		
Gate-Source Charge	Q _{gs}	V _{DS} =15V,I _D =6A,	-	1.6	-	nC		
Gate-Drain Charge	Q_{gd}	- V _{GS} =4.5V	-	2.1	-	nC		
Drain-Source Diode Characteristics								
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =6A	-	-	1.2	V		
Diode Forward Current (Note 2)	Is		-	-	6	Α		
	_							

Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature. **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

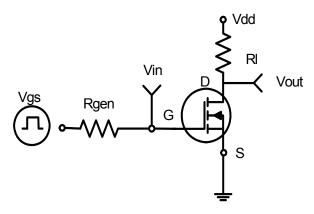
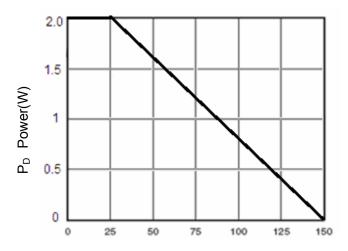


Figure 1:Switching Test Circuit



 T_J -Junction Temperature(°C) Figure 3 Power Dissipation

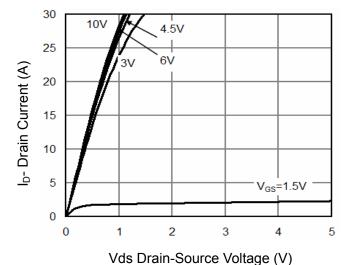


Figure 5 Output Characteristics

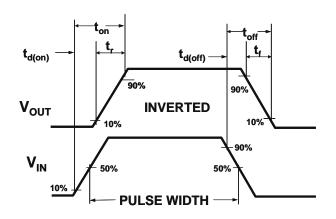


Figure 2:Switching Waveforms

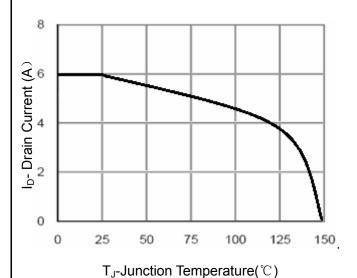


Figure 4 Drain Current

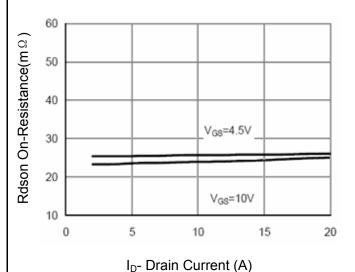
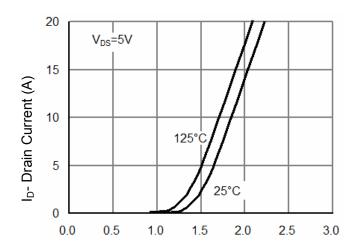
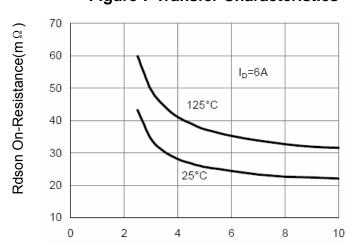


Figure 6 Drain-Source On-Resistance





Vgs Gate-Source Voltage (V)
Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)

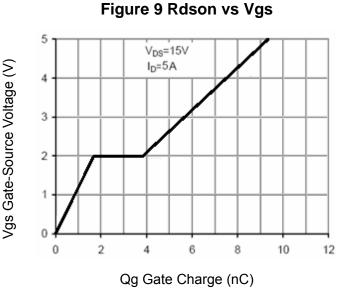


Figure 11 Gate Charge

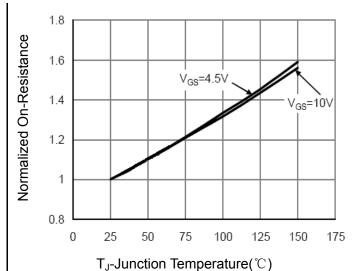


Figure 8 Drain-Source On-Resistance

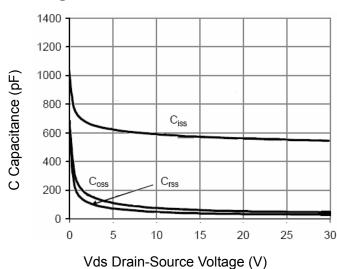


Figure 10 Capacitance vs Vds

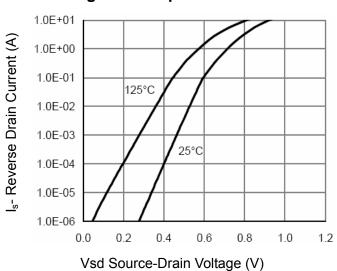
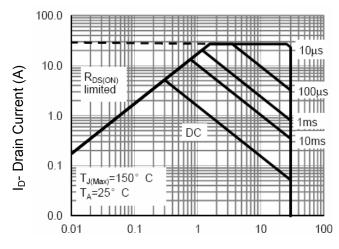


Figure 12 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)

Figure 13 Safe Operation Area

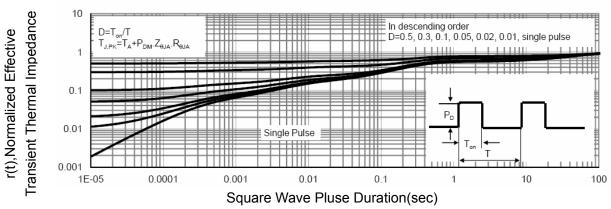
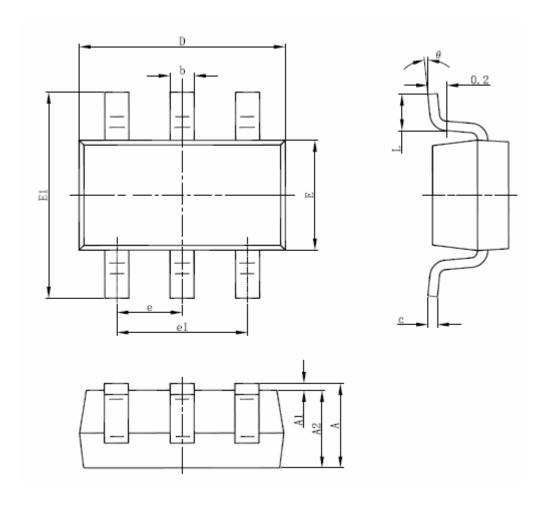


Figure 14 Normalized Maximum Transient Thermal Impedance

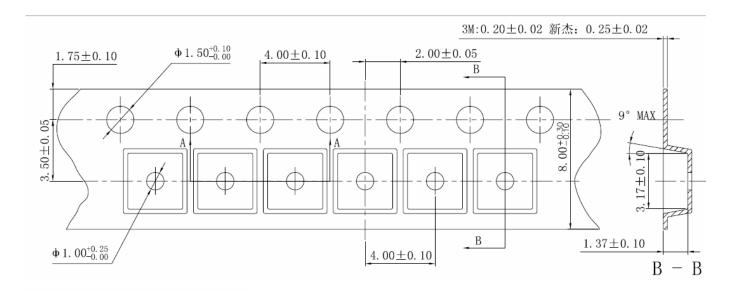


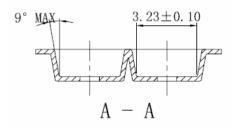
SOT23-6L Package Information



Comb a I	Dimensions In Millimeters		Dimensions	s In Inches
Symbol	Min	Max	Min	Max
Α	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
С	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
е	0.950	(BSC)	0.037	(BSC)
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°







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